Backward Ecal / EEEMCal

Triple I Engineering Meeting Update (03/03/2025)

Julien Bettane







Detector Views

Positioning and clearance

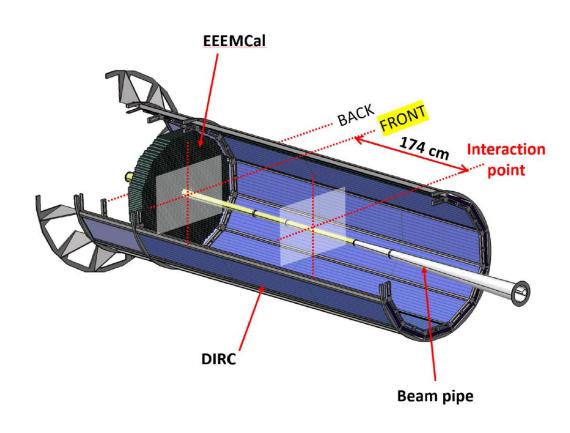
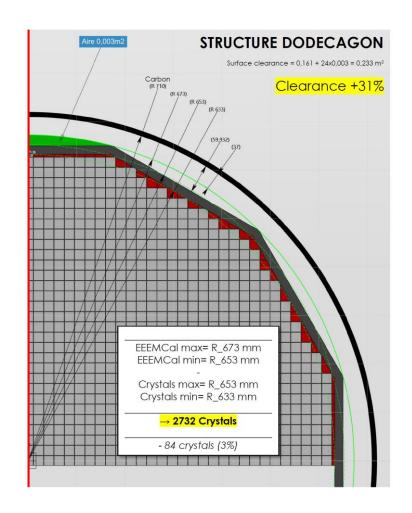
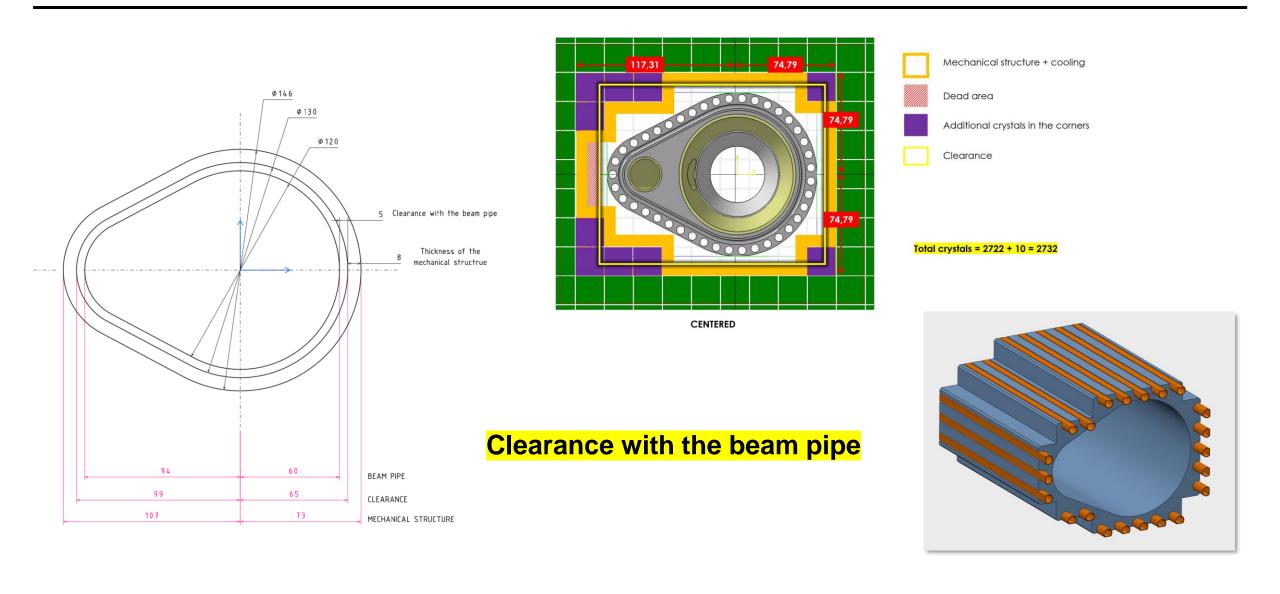


Figure 5: Positioning of the EEEMCal into the ePIC Detector, 176 cm < d < 179 cm for the crystals (ideal position for physics: 174 cm)



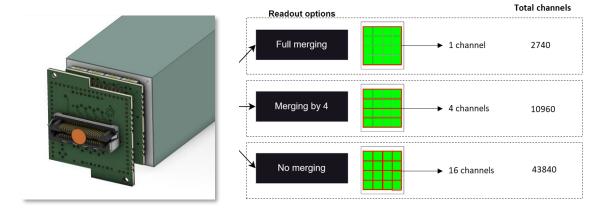
Detector Views



Status / Updates | Beam test & Prototype

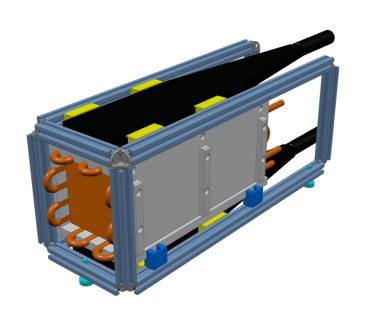
Beam test:

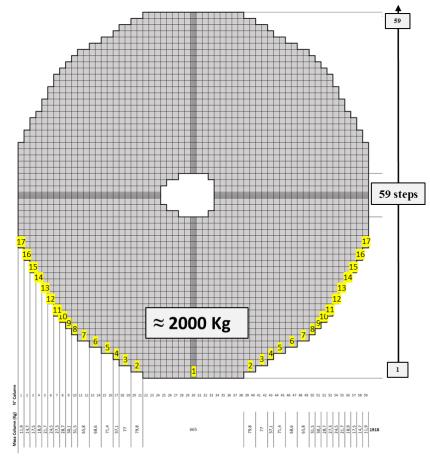
- @DESY : 16th Feb → 02th March 2025
- Test the SiPM readout (among others...)
- Ongoing results/Analysis

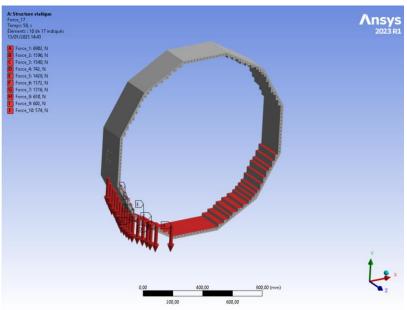


Prototype upgrade:

- Cosmic bench
- 2 scintillators + 2 PMTs
- 25 PWO crystals
- PCB SiPM with different readout
- Beam tests compatible

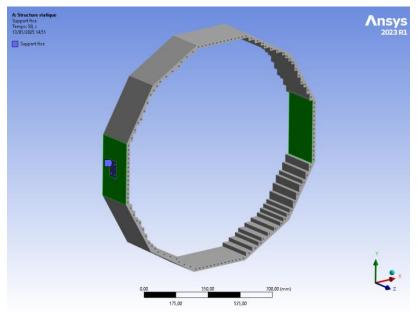






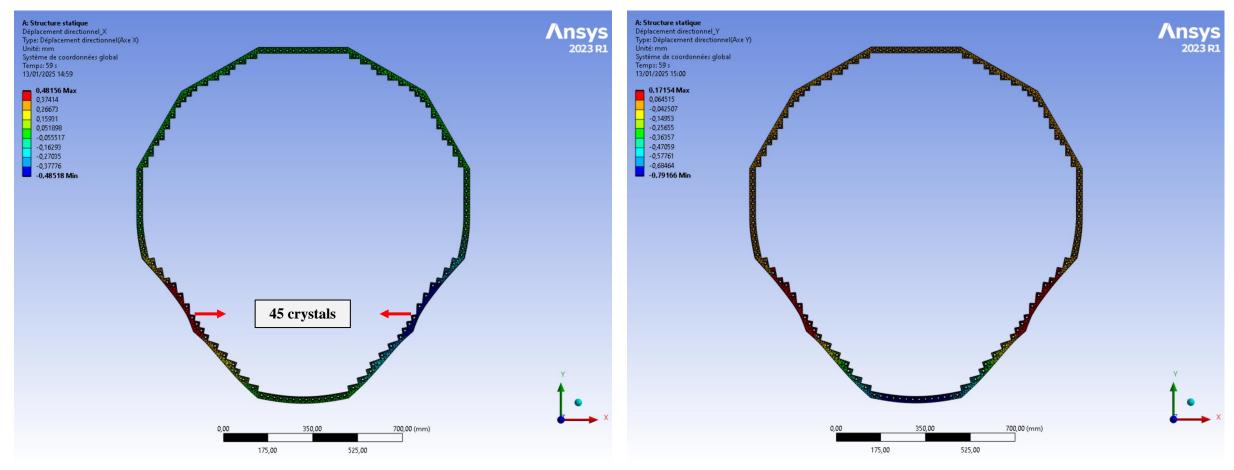


- 1 face at the center
- \rightarrow 665 Kg
- 16 other faces on both sides
- \rightarrow 626,5 Kg x2 (11,9 kg to 79,8 Kg)
- 59 steps to check the deflection during the assembly



FEA Model:

- Worst case: fastened at 3 and 9 o'clock
- The way to fasten the structure increase the results in terms of stress

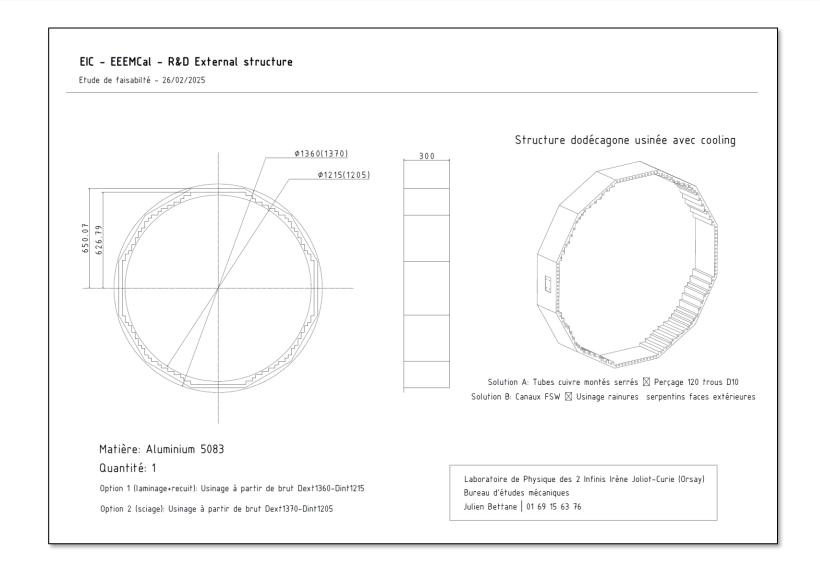


Displacement X < 0,5 mm

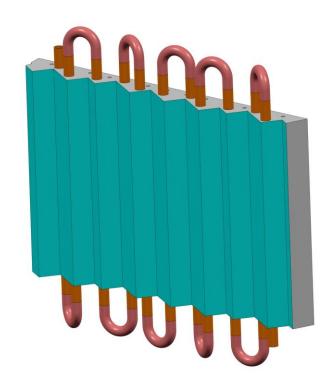
Displacement Y < 0,8 mm

Mechanical feasibility study

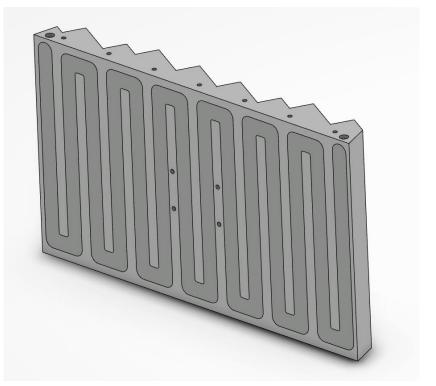
- ☐ How to cool?
- → Copper tubes insert in the aluminum
- → FSW + machined coil
- ☐ How to build the structure?
- → Foundry (not selected)
- → Machining (bandsaw cutting)



Mechanical prototypes to compare the feasibilty and the efficiency of the cooling



→ Copper tubes insert in the aluminum

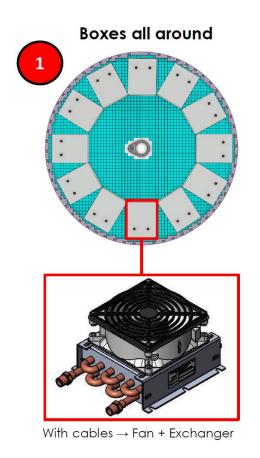


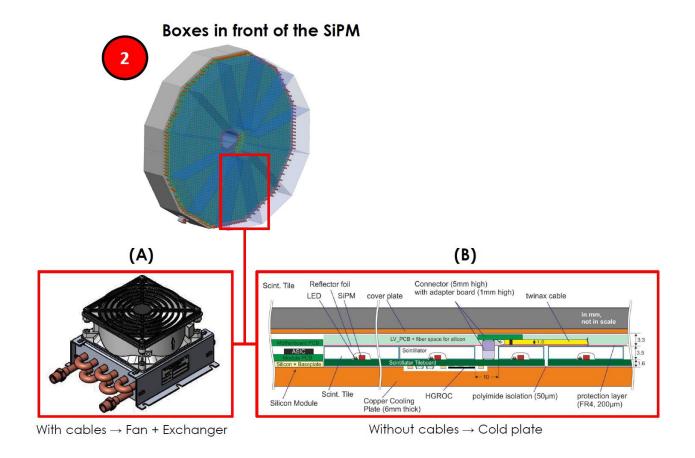
→ FSW + machined coil

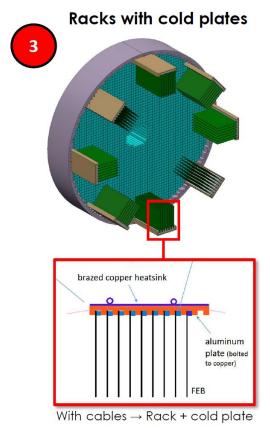
Quotation under preparation

Status / Updates | FEB

3 main options for the Front End Board



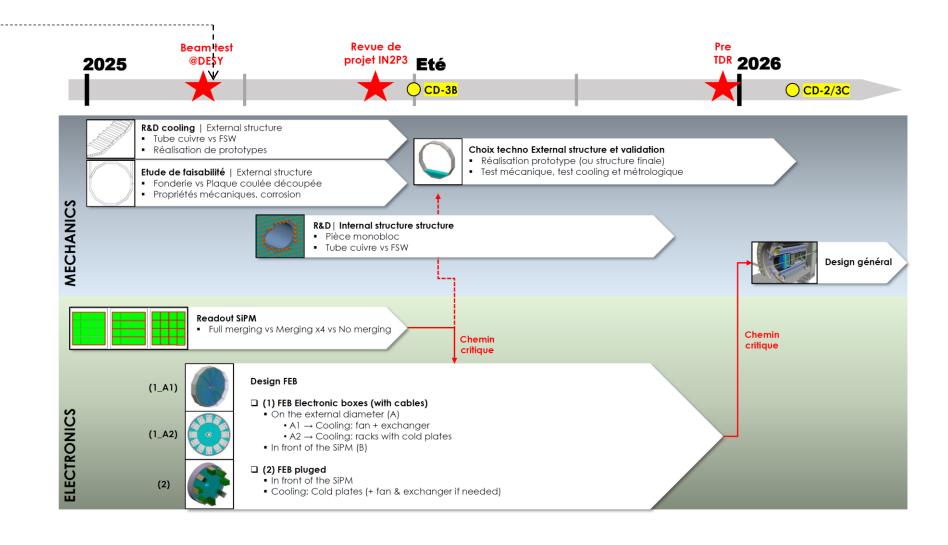




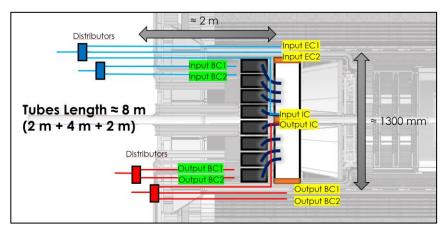
Plans Towards PDR



Mechanical Design Report



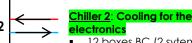
Services Estimates



Chillers

Chiller 1: Cooling for the crystals

- External cooling EC (2 systems)
- Internal cooling IC (1 sytem)
- ΔT room = 3°C \rightarrow 50 W for the crystals



- 12 boxes BC (2 sytems)
- 120 W per box (1500 W)

Tubing drawing of the cooling

Cables:

- LED (1 LED per crystal → controlled by the FEB)
- Thermal sensors (10% of the crystals x2 → 600 cables)
- Signal cables (Depend on the regroupment, reading with 16 SiPM vs 4 SiPM)
- Power supply cables



